

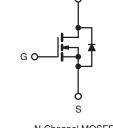
**Vishay Siliconix** 



## **Power MOSFET**

PRODUCT SUMMA	RY		
V <sub>DS</sub> (V)	100		
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 10 V$	0.27	
Q <sub>g</sub> (Max.) (nC)	16		
Q <sub>gs</sub> (nC)	4.4		
Q <sub>gd</sub> (nC)	7.7		
Configuration	Sing	le	





N-Channel MOSFET

### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lood (Pb) free	IRFD120PbF
Lead (Pb)-free	SiHFD120-E3
SnPb	IRFD120
SIFD	SiHFD120

<b>ABSOLUTE MAXIMUM RATINGS (TA</b>	= 25 °C, unless otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V <sub>DS</sub>	100	V
Gate-Source Voltage		V <sub>GS</sub>	± 20	v
Continuous Drain Current	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_A = 25 \text{ °C}}{T_A = 100 \text{ °C}}$		1.3	
Continuous Drain Current	$T_A = 100 ^{\circ}C$	ID	0.94	А
Pulsed Drain Current <sup>a</sup>	· · ·	I <sub>DM</sub>	10	
Linear Derating Factor			0.0083	W/°C
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	100	mJ
Repetitive Avalanche Current <sup>a</sup>		I <sub>AR</sub>	1.3	А
Repetitive Avalanche Energy <sup>a</sup>		E <sub>AR</sub>	0.13	mJ
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.3	W
Peak Diode Recovery dV/dt <sup>c</sup>		dV/dt	5.5	V/ns
Operating Junction and Storage Temperature Rang	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175		
Soldering Recommendations (Peak Temperature)	for 10 s		300 <sup>d</sup>	- °C

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD}$  = 25 V, starting T<sub>J</sub> = 25 °C, L = 22 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 2.6 A (see fig. 12).

c.  $I_{SD} \leq 9.2$  A, dl/dt  $\leq 110$  A/µs,  $V_{DD} \leq V_{DS}, \, T_J \leq 175$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	120	°C/W

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0 V, I <sub>D</sub> = 250 μA	100	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Referen	ce to 25 °C, I <sub>D</sub> = 1 mA	-	0.13	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub>	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zara Cata Valtaga Drain Current	1	V <sub>DS</sub> :	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$		-	- 25	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 80 V			-	250	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}$	I <sub>D</sub> = 0.78 A <sup>b</sup>	-	-	0.27	Ω
Forward Transconductance	<b>g</b> <sub>fs</sub>	V <sub>DS</sub> =	= 50 V, I <sub>D</sub> = 0.78 A <sup>b</sup>	0.80	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V	-	360	-	
Output Capacitance	Coss	1	$V_{DS} = 25 V$	-	150	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.	.0 MHz, see fig. 5	-	34	-	
Total Gate Charge	Qg			-	-	16	
Gate-Source Charge	$Q_gs$	$V_{GS} = 10 V$	I <sub>D</sub> = 9.2 A, V <sub>DS</sub> = 80 V see fig. 6 and 13 <sup>b</sup>	-	-	4.4	nC
Gate-Drain Charge	$Q_gd$			-	-	7.7	
Turn-On Delay Time	t <sub>d(on)</sub>			-	6.8	-	
Rise Time	t <sub>r</sub>	Voo	= 50 V, I <sub>D</sub> = 9.2 A	-	27	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>		$R_{\rm D} = 5.2 \ \Omega$ , see fig. 10 <sup>b</sup>	-	18	-	115
Fall Time	t <sub>f</sub>			-	17	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead 6 mm (0.25") 1	from	-	4.0	-	
Internal Source Inductance	L <sub>S</sub>	die contact		-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s	·		•			
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the		-	-	1.3	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	p - n junction		-	-	10	A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	$I_{\rm S}$ = 1.3 A, $V_{\rm GS}$ = 0 V <sup>b</sup>	-	-	2.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 05 %0 1	0.0.4 dl/dt 100.4/b	-	130	260	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$I_{\rm J} = 25$ °C, $I_{\rm F}$	= 9.2 A, dl/dt = 100 A/µs <sup>b</sup>	-	0.65	1.3	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	y L <sub>S</sub> and	L <sub>D</sub> )

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



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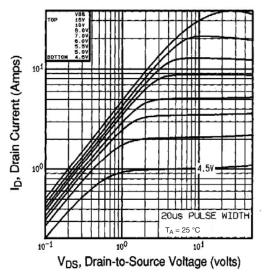


Fig. 1 - Typical Output Characteristics,  $T_A = 25 \ ^\circ C$ 

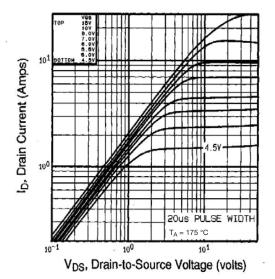
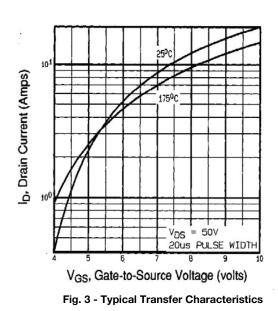


Fig. 2 - Typical Output Characteristics,  $T_A = 175 \ ^\circ C$ 



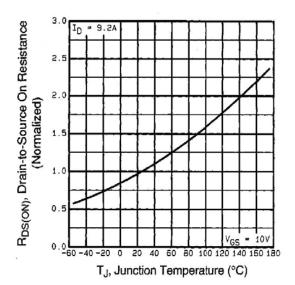


Fig. 4 - Normalized On-Resistance vs. Temperature

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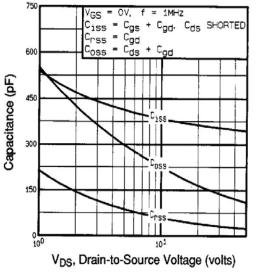
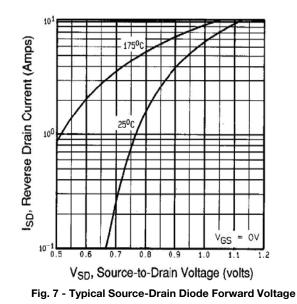
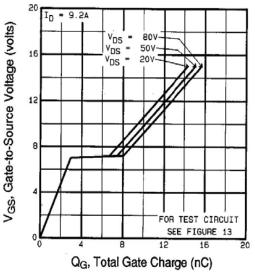
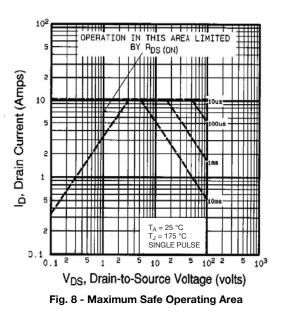


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage











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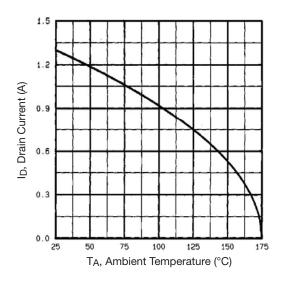


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

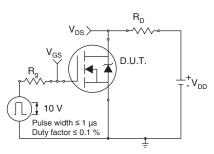


Fig. 10a - Switching Time Test Circuit

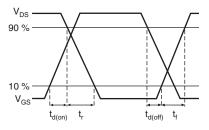


Fig. 10b - Switching Time Waveforms

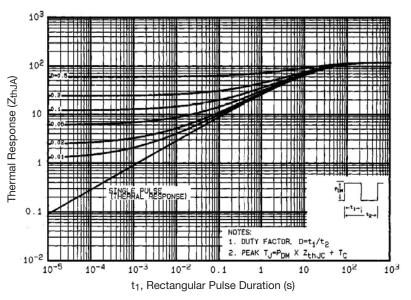


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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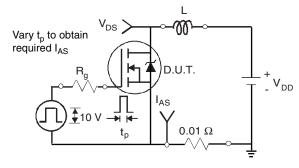


Fig. 12a - Unclamped Inductive Test Circuit

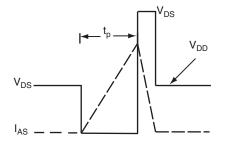


Fig. 12b - Unclamped Inductive Waveforms

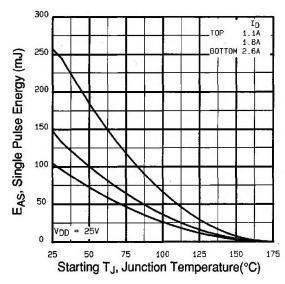


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

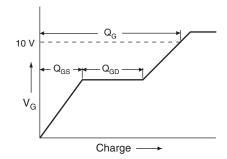


Fig. 13a - Basic Gate Charge Waveform

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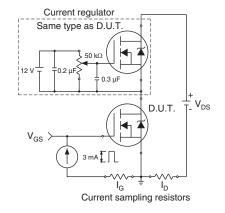
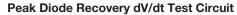
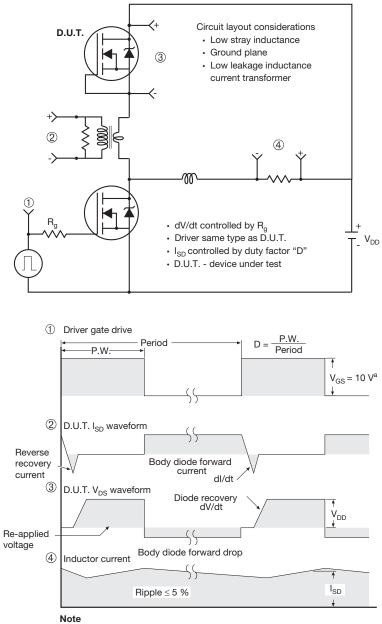


Fig. 13b - Gate Charge Test Circuit



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a.  $V_{GS} = 5$  V for logic level devices

Fig. 14 - For N-Channel

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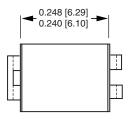
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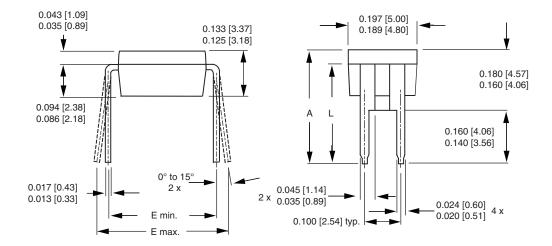


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### HVM DIP (High voltage)





X. MIN. MA 30 7.87 8.3	
	38
25 7.62 10.	79
90 6.86 7.3	36

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



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